

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT4157756

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FORMOSA EPITAXY INCORPORATION	09/22/2016
RECEIVING PARTY DATA	
Name:	EPISTAR CORPORATION
Street Address:	5 LI-HSIN 5TH RD.
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300, R.O.C.
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15356183
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	FEI/0004USC01
NAME OF SUBMITTER:	KEITH TABOADA
SIGNATURE:	/Keith Taboada/
DATE SIGNED:	11/28/2016
Total Attachments: 1	
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ASSIGNMENT FORMOSA EPITAXY INCORPORATION TO EPISTAR CORPORATION

WHEREAS, FORMOSA EPITAXY INCORPORATION, a corporation of Taiwan, Republic of China, having a place of business at No. 99, Longyuan 1st Road, Longtan Township, Taoyuan County, Taiwan (hereinafter referred to as Assignor), have title to certain United States Patents identified as:

- US Patent Application Serial No.:	Filing Date
14/529453	2014/10/31
61/693853	2012/08/28
14/268092	2014/05/02
14/641565	2015/03/09

WHEREAS, EPISTAR CORPORATION, a corporation of Taiwan, Republic of China, having a place of business at 5 Li-Hsin 5th Rd., Science-based Industrial Park, Hsinchu, Taiwan 300, R.O.C. (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said US patent applications (hereinafter referred to as Applications), and the inventions disclosed therein (hereinafter referred to as Inventions), and in and to all embodiments of the Inventions, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignor to have been received in full from said Assignee:

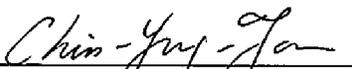
1. Said Assignor hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignor, their respective heirs, legal representatives and assigns.

4. Said Assignor hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor have executed and delivered this instrument to said Assignee on the dates indicated below.


Chin-Yung Fan, Chairman
FORMOSA EPITAXY INCORPORATION

2016.9.22
(Date)